

MEDIA RELEASE

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Ascom and Hisilicon Signed Modem Licensing Agreement

With licensed access to the Hisilicon modem interface, Ascom Network Testing strengthens its test tool support for LTE networks in China and worldwide.

Reston, Va., 27 February 2012 — [Ascom Network Testing](#) and wireless communication chipmaker [Hisilicon Technologies Co., Ltd.](#) today announced a licensing agreement which will address their customers' needs for network testing solutions for 2G, 3G and LTE wireless network rollouts.

The agreement will enable timely support for Hisilicon chipset-based terminals in the network rollout and optimization tools that comprise Ascom's [TEMS™ Portfolio](#). This will add the TEMS LTE/3G/2G portfolio and demonstrate both companies' commitment to their operator and equipment vendor customers' success in planning, deploying and optimizing LTE/3G/2G networks.

"Ascom is very pleased to partner with Hisilicon, whose TD-LTE products have proved to be very successful in China," says Erik Tarnvik, Vice President of Marketing, Ascom Network Testing. He adds, "As the network testing market leader, Ascom Network Testing integrates with more technologies, devices, chipsets, and interfaces than any other supplier in the industry, enabling customers to easily switch between different technologies – and even between different generations of technologies – while still using the same test tools. We are constantly looking for new partners that can fulfill market needs, and Hisilicon fits that profile."

"As Hisilicon-based terminals gain wider acceptance in the market, network operators will require advanced solutions to analyze the performance of their LTE and UMTS networks. I'm very pleased that Ascom will work with us in this field," said Wei Ai, Vice President of Hisilicon. "Hisilicon is the first chipset vendor to provide the Cat4(Downlink 150Mbps/Uplink 50Mbps)in LTE and DC+MOMO feature in HSPA,which will get 84Mbps throughput in downlink and 23Mbps in uplink. With Hisilicon's fastest LTE multi-mode platform and Ascom's leading test tools for the air interface, customers will be able to provide high-quality and high performance LTE services."

ABOUT ASCOM

Ascom is an international solution provider with comprehensive technological know-how in Mission-Critical Communication. The company concentrates on core areas such as Wireless Solutions (high-value, customer-specific on-site communications solutions), Network Testing (a global market leader in testing, monitoring, and optimization solutions for mobile networks) and Security Communication (applications for security, communication and control systems for infrastructure operators, public security institutions and the army). The company has subsidiaries in 20 countries and a workforce of about 2,300 employees worldwide. Ascom registered shares (symbol ASCN) are listed on the SIX Swiss Exchange in Zurich.

About Hisilicon

Hisilicon Technologies Co., Ltd. was established in October 2004. Formerly known as ASIC Design Center of Huawei Technologies was founded in 1991. With headquarters in Shenzhen , China, Hisilicon has set up design divisions in Beijing, Shanghai, Silicon Valley (USA) and Sweden. By the end of 2011, there were more than 4000 employees in Hisilicon, 67% of them possessing a doctor or masters degree. Meeting customers' demands are the driving force for Hisilicon. It always aims to provide high quality chip solutions with great services and quick response to customers' request. Please visit www.hisilicon.com for more information.

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